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April 1st, 2010 Renesas Electronics Corporation

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The semiconductor operations of Hitachi and Mitsubishi Electric were transferred to Renesas Technology Corporation on April 1st 2003. These operations include microcomputer, logic, analog and discrete devices, and memory chips other than DRAMs (flash memory, SRAMs etc.) Accordingly, although Mitsubishi Electric, Mitsubishi Electric Corporation, Mitsubishi Semiconductors, and other Mitsubishi brand names are mentioned in the document, these names have in fact all been changed to Renesas Technology Corp. Thank you for your understanding. Except for our corporate trademark, logo and corporate statement, no changes whatsoever have been made to the contents of the document, and these changes do not constitute any alteration to the contents of the document itself.

Note : Mitsubishi Electric will continue the business operations of high frequency & optical devices and power devices.

Renesas Technology Corp. Customer Support Dept. April 1, 2003





DESCRIPTION

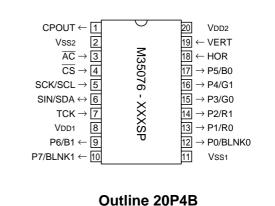
The M35076-XXXSP is a character pattern display control IC can display on the digital camera, the digital video, the digital television, the CRT display, the liquid crystal display and the plasma display. It can display 2 pages (24 characters × 12 lines per 1 page) at the same time. It uses a silicon gate CMOS process and it housed in a 20-pin shrink DIP package (M35076-XXXSP). For M35076-001SP that is a standard ROM version of M35076-XXXSP respectively, the character pattern is also mentioned.

the same time. It uses a silicon gate CMOS process and it housed in a 20-pin shrink DIP package (M35076-XXXSP). For M35076-001SP that is a standard ROM version of M35076- XXXSP respectively, the character pattern is also mentioned.
FEATURES • Screen composition
 Character sizes available
 Duty : 25%, 50%, or 75% Data input By the 16-bit serial input function
Background coloring
Blanking Character size blanking Border size blanking Matrix-outline blanking All blanking (all raster area)
 Output ports 8 shared output ports (toggled between RGB output) Display RAM erase function Display oscillation stop function VDD=5V> Display input frequency range
External clock mode 1 Fosc = 6.3 MHz to 80.0 MHz External clock mode 2 Fosc = 20.0 MHz to 110.0 MHz Internal clock mode Fosc = 20.0 MHz to 110.0 MHz • Horizontal synchronous input frequency
<vdd=3v> Display input frequency range External clock mode 1</vdd=3v>

APPLICATION

Digital camera, Digital video, Digital television, CRT display, Liquid crystal display, Plasma display

PIN CONFIGURATION (TOP VIEW)





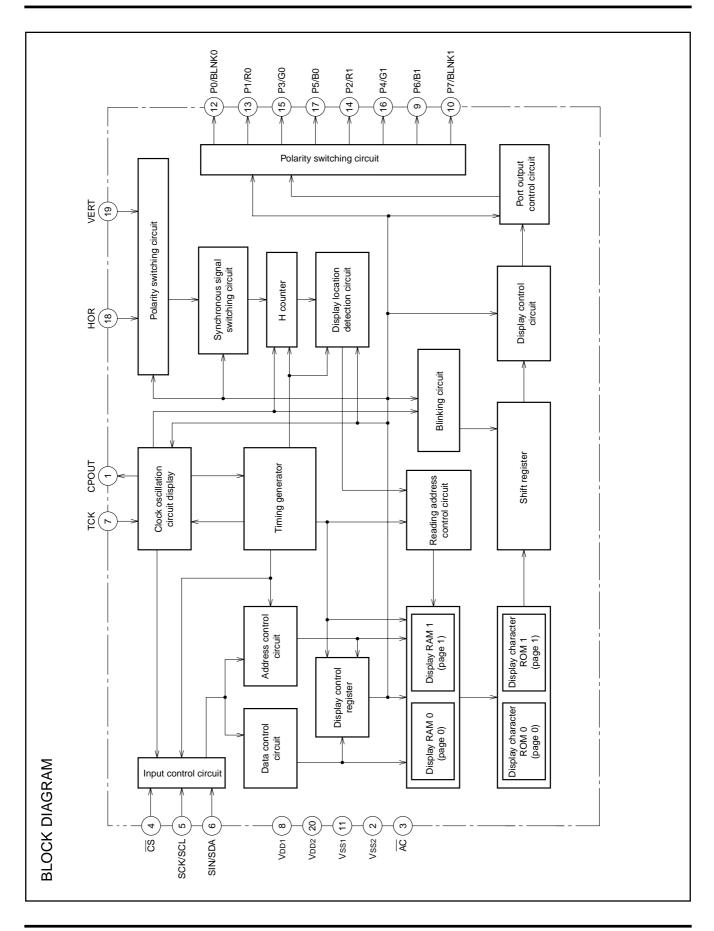


PIN DESCRIPTION

Pin Number	Symbol	Pin name	Input/ Output	Function
1	CPOUT	Filter output	Output	Filter output. Connect loop filter to this pin.
2	VSS2	Earthing pin	-	Connect to GND.
3	ĀC	Auto-clear input	Input	When "L", this pin resets the internal IC circuit. Hysteresis input. Built-in pull-up resistor.
4	ĊŚ	Chip select input	Input	<at 16-bit="" communication="" serial="" the=""> Chip select pin. Set this pin to "L" level at serial data transfer. Hysteresis input. Built-in pull-up resistor.</at>
				<at i<sup="" the="">2C-BUS serial communication> Set this pin to "H" level.</at>
5	SCK/SCL	Clock input	Input	<at 16-bit="" communication="" serial="" the=""> SIN pin serial data is taken in when SCK rises at \overline{CS} pin "L" level. Hysteresis input.</at>
				<at i<sup="" the="">2C-BUS serial communication> SDA pin serial data is taken in synchronized with SCL.</at>
6	SIN/SDA	Data input	Input	<at 16-bit="" communication="" serial="" the=""> This is the pin for serial input of display control register and display RAM data. Hysteresis input.</at>
		 Data I/O	I/O	<at l<sup="" the="">2C-BUS serial communication> Hysteresis input. This is the pin for serial input of display control register and display RAM data. Also this pin output acknowledge signal.</at>
7	тск	External clock	Input	This is the pin for external clock input.
8	VDD1	Power pin	-	Please connect to +5V with the power pin.
9	P6/B1	Port P6 output	Output	This pin can be toggled between port pin output and B1 signal output.
10	P7/BLNK1	Port P7 output	Output	This pin can be toggled between port pin output and BLNK1 signal output.
11	VSS1	Earthing pin	-	Please connect to GND using circuit earthing pin.
12	P0/BLNK0	Port P0 output	Output	This pin can be toggled between port pin output and BLNK0 signal output.
13	P1/R0	Port P1 output	Output	This pin can be toggled between port pin output and R0 signal output.
14	P2/R1	Port P2 output	Output	This pin can be toggled between port pin output and R1 signal output.
15	P3/G0	Port P3 output	Output	This pin can be toggled between port pin output and G0 signal output.
16	P4/G1	Port P4 output	Output	This pin can be toggled between port pin output and G1 signal output.
17	P5/B0	Port P5 output	Output	This pin can be toggled between port pin output and B0 signal output.
18	HOR	Horizontal synchro- nous signal input	Input	This pin inputs the horizontal synchronous signal. Hysteresis input.
19	VERT	Vertical synchro- nous signal input	Input	This pin inputs the vertical synchronous signal. Hysteresis input.
20	Vdd2	Power pin	-	Please connect to +5V with the power pin.









SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

MEMORY CONSTITUTION

Address 00016 to 11F16 are assigned to the display RAM, address 12016 to 12816 are assigned to the display control registers. The internal circuit is reset and all display control registers (address 12016 to 12816) are set to "0" when the \overline{AC} pin level is "L". And then, RAM is not erased and be undefinited. This memory is consisted of 2

pages : page 0 memory and page 1 memory (their addresses are common), page controlled by DAF bit of each address when writing data. For detail, see "Data input". Memory constitution is shown in Figure 1 and 2.

Addresses	DAF	DAE	DAD	DAC	DAB	DAA	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0
00016	0	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
00116	0	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
		11	ackgrou coloring		Blink- ing	Char	acter co	blor			C	Characte	r code			
11E16	0	вв	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
11F16	0	вв	BG	BR	BLINK	в	G	R	C7	C6	C5	C4	C3	C2	C1	C0
12016	0	ЕХСК0	DISV2	DIVS1	DIVS0	DIV10	DIV9	DIV8	DIV7	DIV6	DIV5	DIV4	DIV3	DIV2	DIV1	DIV0
12116	0	RSEL0	PTD7	PTD6	PTD5	PTD4	PTD3	PTD2	PTD1	PTD0	PTC5	PTC4	PTC3	PTC2	PTC1	PTC0
12216	0	RSEL1	SPACE2	SPACE1	SPACE0	HP10	HP9	HP8	HP7	HP6	HP5	HP4	HP3	HP2	HP1	HP0
12316	0	EXCK1	TEST3	TEST2	TEST1	TEST0	VP9	VP8	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0
12416	0	TEST9	PTC67	TEST4	DSP11	DSP10	DSP9	DSP8	DSP7	DSP6	DSP5	DSP4	DSP3	DSP2	DSP1	DSP0
12516	0	TEST10	VSZ1H1	VSZ1H0	VSZ1L1	VSZ1L0	V1SZ1	V1SZ0	LIN9	LIN8	LIN7	LIN6	LIN5	LIN4	LIN3	LIN2
12616	0	POPUP	VSZ2H1	VSZ2H0	VSZ2L1	VSZ2L0	V18SZ1	V18SZ0	LIN17	LIN16	LIN15	LIN14	LIN13	LIN12	LIN11	LIN10
12716	0	MODE0	TEST12	HSZ20	TEST11	HSZ10	BETA14	TEST8	TEST7	TEST6	FB	FG	FR	RB	RG	RR
12816	0	MODE1	BLINK2	BLINK1	BLINK0	DSPON	STOP	RAMERS	SYAD	BLK1	BLK0	POLH	POLV	VMASK	B/F	BCOL

Fig. 1 Memory constitution (page 0 memory)



SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

Addresses	DAF	DAE	DAD	DAC	DAB	DAA	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0
00016	1	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
00116	1	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
			ackgrou coloring	nd	Blink- ing	Cha	racter co	blor			Cł	naracter	code			
11E16	1	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
11F16	1	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0
12016	1	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
12116	1	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
12216	1	-	SPACE2	SPACE1	SPACE0	HP10	HP9	HP8	HP7	HP6	HP5	HP4	HP3	HP2	HP1	HP0
12316	1	-	TEST3	VJT	TEST1	TEST0	VP9	VP8	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0
12416	1	-	-	TEST4	DSP11	DSP10	DSP9	DSP8	DSP7	DSP6	DSP5	DSP4	DSP3	DSP2	DSP1	DSP0
12516	1	-	VSZ1H1	VSZ1H0	VSZ1L1	VSZ1L0	V1SZ1	V1SZ0	LIN9	LIN8	LIN7	LIN6	LIN5	LIN4	LIN3	LIN2
12616	1	-	VSZ2H1	VSZ2H0	VSZ2L1	VSZ2L0	V18SZ1	V18SZ0	LIN17	LIN16	LIN15	LIN14	LIN13	LIN12	LIN11	LIN10
12716	1	-	TEST12	HSZ20	TEST11	HSZ10	BETA14	TEST8	TEST7	TEST6	FB	FG	FR	RB	RG	RR
12816	1	-	BLINK2	BLINK1	BLINK0	DSPON	TEST13	RAMERS	SYAD	BLK1	BLK0	_	-	_	-	BCOL

Fig. 2 Memory constitution (page 1 memory)

Note: Page 0 and page 1 registers are found in their respective pages. For example, HP10 to HP0 of the page 0 memory sets the horizontal display start position of page 0, whereas HP10 to HP0 (same register name) of the page 1 memory sets the horizontal display start position of page 1. Also, registers common to both page 0 and page 1 are found only in the page 0 memory. For example, PTC0 is the control register of the P0 pin and is found only in the page 0 memory.





SCREEN CONSTITUTION

The screen lines and rows are determined from each address of the display RAM (page 0 and page 1 are common). The screen constitution is shown in Figure 3.

Row Line	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22	23	24
1	00016	00116	00216	00316	00416	00516	00616	00716	00816	00916	00A16	00B16	00C16	00D16	00E16	00F16	01016	01116	01216	01316	01416	01516	01616	01716
2	01816	01916	01A16	01B16	01C16	01D16	01E16	01F16	02016	02116	02216	02316	02416	02516	02616	02716	02816	02916	02A16	02B16	02C16	02D16	02E16	02F16
3	03016	03116	03216	03316	03416	03516	03616	03716	03816	03916	03A16	03B16	03C16	03D16	03E16	03F16	04016	04116	04216	04316	04416	04516	04616	04716
4	04816	04916	04A16	04B16	04C16	04D16	04E16	04F16	05016	05116	05216	05316	05416	05516	05616	05716	05816	05916	05A16	05B16	05C16	05D16	05E16	05F16
5	06016	06116	06216	06316	06416	06516	06616	06716	06816	06916	06A16	06B16	06C16	06D16	06E16	06F16	07016	07116	07216	07316	07416	07516	07616	07716
6	07816	07916	07A16	07B16	07C16	07D16	07E16	07F16	08016	08116	08216	08316	08416	08516	08616	08716	08816	08916	08A16	08B16	08C16	08D16	08E16	08F16
7	09016	09116	09216	09316	09416	09516	09616	09716	09816	09916	09A16	09B16	09C16	09D16	09E16	09F16	0A016	0A116	0A216	0A316	0A416	0A516	0A616	0A716
8	0A816	0A916	0AA16	0AB16	0AC16	0AD16	0AE16	0AF16	0B016	0B116	0B216	0B316	0B416	0B516	0B616	0B716	0B816	0B916	0BA16	0BB16	0BC16	0BD16	0BE16	0BF16
9	0C016	0C116	0C216	0C316	0C416	0C516	0C616	0C716	0C816	0C916	0CA16	0CB16	0CC16	0CD16	0CE16	0CF16	0D016	0D116	0D216	0D316	0D416	0D516	0D616	0D716
10	0D816	0D916	0DA16	0DB16	0DC16	0DD16	0DE16	0DF16	0E016	0E116	0E216	0E316	0E416	0E516	0E616	0E716	0E816	0E916	0EA16	0EB16	0EC16	0ED16	0EE16	0EF16
11	0F016	0F116	0F216	0F316	0F416	0F516	0F616	0F716	0F816	0F916	0FA16	0FB16	0FC16	0FD16	0FE16	0FF16	10016	10116	10216	10316	10416	10516	10616	10716
12	10816	10916	10A16	10B16	10C16	10D16	10E16	10F16	11016	11116	11216	11316	11416	11516	11616	11716	11816	11916	11A16	11B16	11C16	11D16	11E16	11F16
	* The	e hexa	adecir	nal n	umbe	rs in t	he bo	oxes s	how	the di	splay	RAM	addr	ess.										

Fig. 3 Screen constitution





DISPLAY RAM

	Desister		Contents	Demerica
DA	Register	Status	Function	Remarks
		0		
0	C0	1	Set the displayed ROM character code.	Set display character
		0	To write data into page 0 (Note 2), select the data from the ROM	
1	C1	1	characters (256 types) for page 0 and set the character code. To	
		0	write data into page 1, do the same from the ROM characters (256 types) for page 1.	
2	C2	1		
		0		
3	C3	1		
		0		
4	C4	1		
		0		
5	C5	1		
		0		
6	C6	1		
		0		
7	C7	1		
		0		
8	R	1	B G R Color 0 0 0 Black	Set character color (character unit)
		0	0 0 1 Red 0 1 0 Green	
9	G	1	0 1 1 Yellow 1 0 0 Blue	
		0	1 0 1 Magenta	
А	В	1	1 1 0 Cyan 1 1 1 White	
		0	Do not blink.	Set blinking
В	BLINK	1	Blinking	See register BLINK2 to BLINK0 (dress12816)
		0	BB BG BR Color	Set character background
С	BR	1	0 0 0 Black	(character unit)
		0	0 0 1 Red 0 1 0 Green	
D	BG	1	0 1 1 Yellow 1 0 0 Blue	
		0	1 0 1 Magenta	
Е	BB	1	1 1 0 Cyan 1 1 1 White	

Notes 1. The display RAM is undefined state at the \overline{AC} pin.

2. The display RAM consists of 2 pages, page 0 and page 1 (common address). The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.





REGISTERS DESCRIPTION

(1) Address 12016

	Degister		Contents	Remarks
DA	Register	Status	Function	Remarks
0	DIV0 (Note 3)	() 1	Set division value (multiply value) of horizontal oscillation frequency.	Set display frequency by division value (multiply value) setting. For details, see REGISTER SUPPLE-
1	DIV1 (Note 3)	① 1	$N1 = \sum_{n=0}^{10} (DIVn \times 2^n)$	MENTARY DESCRIPTION (1). Also, set the display frequency range by
2	DIV2 (Note 3)	() 1	N1 : division value (multiply value)	registers DIVS0, DIVS1(address 12016), RSEL0(address 12116) and RSEL1(address 12216) in accordance with the display frequency.
3	DIV3 (Note 3)	() 1		Any of this settings above is required only when EXCK1 = 0, EXCK0 = 1 and
4	DIV4 (Note 3)	() 1		EXCK1 = 1, EXCK0 = 1.
5	DIV5 (Note 3)	() 1		
6	DIV6 (Note 3)	() 1		
7	DIV7 (Note 3)	() 1		
8	DIV8 (Note 3)	() 1		
9	DIV9 (Note 3)	① 1		
A	DIV10 (Note 3)	() 1		
в	DIVS0 (Note 3)	() 1	For setting, see REGISTER SUPPLEMENTARY DESCRIPTION (2).	Set display frequency range.
с	DIVS1 (Note 3)	() 1		
D	DISV2 (Note 3)	() 1		
E	EXCK0 (Note 3)	0	EXCK1EXCK0Display clock input00External clock mode 101Internal clock mode10Do not set11External clock mode 2	Display clock setting See REGISTER SUPPLEMENTARY DESCRIPTION (1) EXCK1 : address12316

Notes 1. The mark () around the status value means the reset status by the "L" level is input to AC pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.





	Register		Contents	Dementer
DA	Register	Status	Function	Remarks
0	PTC0 (Note 3)	0	P0 output (port P0).	P0 pin output control.
		1	BLNK0 output.	
1	PTC1	0	P1 output (port P1).	P1 pin output control.
	(Note 3)	1	R0 signal output.	
2	PTC2	0	P2 output (port P2).	P2 pin output control.
	(Note 3)	1	R1 signal output.	
3	PTC3	0	P3 output (port P3).	P3 pin output control.
	(Note 3)	1	G0 signal output.	
4	PTC4	0	P4 output (port P4).	P4 pin output control.
	(Note 3)	1	G1 signal output.	
5	PTC5	0	P5 output (port P5).	P5 pin output control.
U	(Note 3)	1	B0 signal output.	
6	PTD0	0	"L" output or negative polarity output (BLNK0 output).	P0 pin data control.
0	(Note 3)	1	"H" output or positive polarity output (BLNK0 output).	
7	PTD1	0	"L" output or negative polarity output (R0 signal output).	P1 pin data control.
,	(Note 3)	1	"H" output or positive polarity output (R0 signal output).	-
8	PTD2	0	"L" output or negative polarity output (R1 signal output).	P2 pin data control.
0	(Note 3)	1	"H" output or positive polarity output (R1 signal output).	
9	PTD3	0	"L" output or negative polarity output (G0 signal output).	P3 pin data control.
9	(Note 3)	1	"H" output or positive polarity output (G0 signal output).	
A	PTD4	0	"L" output or negative polarity output (G1 signal output).	P4 pin data control.
~	(Note 3)	1	"H" output or positive polarity output (G1 signal output).	
	PTD5	0	"L" output or negative polarity output (B0 signal output).	P5 pin data control.
В	(Note 3)	1	"H" output or positive polarity output (B0 signal output).	
•	PTD6	0	"L" output or negative polarity output (B1 signal output).	P6 pin data control.
С	(Note 3)	1	"H" output or positive polarity output (B1 signal output).	
_	PTD7	0	"L" output or negative polarity output (BLNK1 signal output).	P7 pin data control.
D	(Note 3)	1	"H" output or positive polarity output (BLNK1 signal output).	
E	RSEL0 (Note 3)	0	For setting, see REGISTER SUPPLYMENTARY DESCRIPTION (2).	Set display frequency range.

Notes 1. The mark \bigcirc around the status value means the reset status by the "L" level is input to \overline{AC} pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.





DA	Register		Contents	Remarks
DA	Register	Status	Function	Remarks
0	HP0	0	If HS is the horizontal display start location,	Horizontal display start location specified using the 11 bits from HP1
		1	$HS = T \times (\sum_{n=0}^{10} 2^{n} HP_{n} + 6)$	to HP0. HP10 to HP0 = (000000000002) and
1	HP1	0	T : Period of display frequency	(000001001112) setting is forbidden.
			2007 settings are possible.	
2	HP2	0	HOR	
3	HP3	0		
5		1	VS VS	
4	HP4	0		
		1	B Note 4 OSD Display area Note 4	
5	HP5	0		
		1	Note 4	HS* (shown left) shows horizontal display start location that is register E
6	HP6	0	Monitor Screen	(address 12816) = 0 is set.
7	HP7	0		
7		1		
8	HP8	0		
		1		
9	HP9	0		
		1		
А	HP10	1		
в	SPACE0	0	SPACE Number of Lines and Space 2 1 0 <(S) represents space>	Leave one line worth of space in the ve tical direction.
D		1	0 0 0 12	For example, 6 (S) 6 indicates two se of 6 lines with a line of spaces between
с	SPACE1	0	0 0 1 1 (S) 10 (S) 1 0 1 0 2 (S) 8 (S) 2 0 1 1 3 (S) 6 (S) 3	lines 6 and 7. A line is $18 \times N$ horizontal scan lines.
		1	1 0 4 (S) 4 (S) 4 1 0 1 5 (S) 2 (S) 5	N is determined by the character size the vertical direction
D	SPACE2	<u>()</u> 1	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	
E	RSEL1	0	(S) represents one line worth of spac For setting, see REGISTER SUPPLEMENTARY DESCRIPTION (2).	Set display frequency range.

(3) Address 12216

Notes 1. The mark \bigcirc around the status value means the reset status by the "L" level is input to $\overline{\text{AC}}$ pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.

Registers marked with (Note 3) are found only in page 0, therefore the register value does not change when the DAF bit is set to "1".
 Set up the horizontal and vertical display start location so that display range may not exceed it.

Set the character code "FF16" (blank without background) for the display RAM of the part which the display range exceeds.





DA	Register		Contents	Remarks
		Status	Function If VS is the vertical display start location,	
0	VP0	0	$VS = H \times \sum_{n=0}^{9} 2^{n} VPn$	The vertical start location is specified using the 10 bits from VP9 to VP0. VP9 to VP0 = (0000000002) setting is
1	VP1	0	H: Cycle with the horizontal synchronizing pulse	forbidden.
2	VP2	1	1023 settings are possible.	
2		1	HOR	
3	VP3	0		
4	VP4	0		
		1	B HS Note 4 Note 4	
5	VP5	0		HS* (shown left) shows horizontal display start location that is register B/
6	VP6	0	Monitor Screen	(address 128 ₁₆) = 0 is set.
-		1		
7	VP7	0		
8	VP8	0		
		1		
9	VP9	0		
A	TEST0	0	It should be fixed to "0".	
		1	Can not be used.	
в	TEST1	0	It should be fixed to "0".	
		1	Can not be used. It should be fixed to "0".	
С	VJT	1	Can not be used.	
D	TEST3	0	It should be fixed to "0".	
U		1	Can not be used.	
		0	For setting, see Register EXCK0 (address 12016).	Display clock setting

Notes 1. The mark \bigcirc around the status value means the reset status by the "L" level is input to \overline{AC} pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.

3. Registers marked with (Note 3) are found only in page 0, therefore the register value does not change when the DAF bit is set to "1".

4. Set up the horizontal and vertical display start location so that display range may not exceed it.

Set the character code "FF16" (blank without background) for the display RAM of the part which the display range exceeds.





(5) Address 12416

DA	Register		C	ontents		
DA	Register	Status		Function		Remarks
0	DSP0	0	The display mode (blankir screen is set line-by-line, u	ng mode) for line using DSPn (n :	e n on the display = 0 to 11).	Sets the display mode of line 1.
1	DSP1	0	The display mode is deter BLK1 and BLK0 (address	mined by the co 12816). Setting	ombination of registers s are given below.	Sets the display mode of line 2.
2	DSP2	0	0 1	DSPn= "0" atrix-outline border Character Border	DSPn= "1" Matrix-outline Border	Sets the display mode of line 3.
3	DSP3	0	1 0 1 1	Matrix-outline	Matrix-outline Character egister BCOL = "0")	Sets the display mode of line 4.
4	DSP4	0	For detail, see DISPLAY F	FORM1(1).		Sets the display mode of line 5.
5	DSP5	0				Sets the display mode of line 6.
6	DSP6	0				Sets the display mode of line 7.
7	DSP7	0				Sets the display mode of line 8.
8	DSP8	0				Sets the display mode of line 9.
9	DSP9	0				Sets the display mode of line 10.
A	DSP10	0				Sets the display mode of line 11.
В	DSP11	0				Sets the display mode of line 12.
С	TEST4	0	It should be fixed to "0". Can not be used.			
D	PTC67 (Note 3)	0	P6 output (port P6) and P7 o B1 output and BLNK output			P6 pin and P7 pin output control.
E	TEST9 (Note 3)	0	Set to "0" in internal clock Set to "1" in external clock			_

Notes 1. The mark () around the status value means the reset status by the "L" level is input to AC pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.





(6) Address 12516

DA	Periotor		Contents	
DA	Register	Status	Function	Remarks
0	LIN2	0	The vertical dot size for line n in the character dot lines (18 vertical lines) is set using LINn (n = 2 to 17).	Character size setting in the vertical direction for the 2nd line.
1	LIN3	0	Dot size can be selected between 2 types for each dot line.	Character size setting in the vertical direction for the 3rd line.
2	LIN4	0	For dot size, see the below registers. Line 1 and lines 2 to 12 can be set independent of one another.	Character size setting in the vertical direction for the 4th line.
3	LIN5	0	LINn = "0" LINn = "1" 1st line Refer to VSZ1L0 and VSZ1L1 Refer to VSZ1H0 and VSZ1H1 2nd to 12th Refer to VSZ2L0 Refer to VSZ2H0	Character size setting in the vertical direction for the 5th line.
4	LIN6	0	line and VSZ2L1 and VSZ2H1	Character size setting in the vertical direction for the 6th line.
5	LIN7	0		Character size setting in the vertical direction for the 7th line.
6	LIN8	0		Character size setting in the vertical direction for the 8th line.
7	LIN9	0 1		Character size setting in the vertical direction for the 9th line.
8	V1SZ0	0 1	H: Cycle with the horizontal synchronizing pulse	Character size setting in the vertical direction for the 1st line. (display monitor 1 to 12 line)
9	V1SZ1	0	0 1 2H/dot 1 0 3H/dot 1 1 4H/dot	
A	VSZ1L0	0 1	H: Cycle with the horizontal synchronizing pulse	Character size setting in the vertical direction (display monitor 1 line) at "C state in register LIN2 to LIN17
В	VSZ1L1	0 1	0 1 2H/dot 1 0 3H/dot 1 1 4H/dot	(address 12516, 12616).
С	VSZ1H0	0	H: Cycle with the horizontal synchronizing pulse VSZ1H1 VSZ1H0 Vertical direction size 0 0 1H/dot	Character size setting in the vertical direction (display monitor 1 line) at "1 state in register LIN2 to LIN17
D	VSZ1H1	0	0 1 2H/dot 1 0 3H/dot 1 1 4H/dot	(address 12516, 12616).
E	TEST10	0	It should be fixed to "0".	

Notes 1. The mark () around the status value means the reset status by the "L" level is input to AC pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.





DA	Bogistor		Contents	
DA	Register	Status	Function	Remarks
0	LIN10	0	The vertical dot size for line n in the character dot lines (18 vertical lines) is set using LINn (n = 2 to 17).	Character size setting in the vertical direction for the 10th line.
1	LIN11	0	Dot size can be selected between 2 types for each dot line.	Character size setting in the vertical direction for the 11th line.
2	LIN12	0	For dot size, see the below registers. Line 1 and lines 2 to 12 can be set independent of one another.	Character size setting in the vertical direction for the 12th line.
3	LIN13	0	LINn = "0" LINn = "1" 1st line Refer to VSZ1L0 and VSZ1L1 Refer to VSZ1H0 and VSZ1H1 2nd to 12th Refer to VSZ2L0 Refer to VSZ2H0	Character size setting in the vertical direction for the 13th line.
4	LIN14	0	line and VSZ2L1 and VSZ2H1	Character size setting in the vertical direction for the 14th line.
5	LIN15	0		Character size setting in the vertical direction for the 15th line.
6	LIN16	0		Character size setting in the vertical direction for the 16th line.
7	LIN17	0		Character size setting in the vertical direction for the 17th line.
8	V18SZ0	0	H: Cycle with the horizontal synchronizing pulse	Character size setting in the vertical direction for the 18th line. (display monitor 1 to 12 line)
9	V18SZ1	0	0 1 2H/dot 1 0 3H/dot 1 1 4H/dot	
A	VSZ2L0	0	H: Cycle with the horizontal synchronizing pulse	Character size setting in the vertical direction (display monitor for 2 to 12 line) at "0" state in register LIN2 to
В	VSZ2L1	0	0 1 2H/dot 1 0 3H/dot 1 1 4H/dot	LINÍ7 (address 12516, 12616).
С	VSZ2H0	0	H: Cycle with the horizontal synchronizing pulse VSZ2H1 VSZ2H0 Vertical direction size 0 0 1H/dot	Character size setting in the vertical direction (display monitor for 2 to 12
D	VSZ2H1	0	0 1 2H/dot 1 0 3H/dot 1 1 4H/dot	line) at "0" state in register LIN2 to LIN17 (address 12516, 12616).
Е	POPUP (Note 3)	0	Page 1 priority display Page 0 priority display	Sets the priority page for when 2 pages ard displayed at the same time. The setting is effective only when the standard display mode is set as MODE0 = "0", MODE1 = "0"

Notes 1. The mark \bigcirc around the status value means the reset status by the "L" level is input to \overline{AC} pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.





DA	Periotor		Contents	
DA	Register	Status	Function	Remarks
0		0	RB RG RR Color	Sate the restor color of all blankings
0	RR	1	0 0 0 Black	Sets the raster color of all blankings.
			0 0 1 Red 0 1 0 Green	
1	RG	0	0 1 1 Yellow	
		1	1 0 0 Blue 1 0 1 Magenta	
2		0	1 1 0 Cyan	
۷	RB	1	1 1 1 White	
3	FR	0	FB FG FR Color	Sets the blanking color of the Border
-		1	0 0 0 Black 0 0 1 Red	size, or the shadow size.
		0	0 1 0 Green	
4	FG		0 1 1 Yellow 1 0 0 Blue	
		1	1 0 1 Magenta	
5	FB	0	1 1 0 Cyan 1 1 1 White	
		1		
6	TEST6	0	It should be fixed to "0".	
		1	Can not be used.	
7	TEST7	0	It should be fixed to "0".	
		1	Can not be used.	
8	TEST8	0	It should be fixed to "0".	
		1	Can not be used.	
9	BETA14	0	Matrix-outline display (12 \times 18 dot)	
		1	Matrix-outline display (14 $ imes$ 18 dot)	
А	HSZ10	0	HSZ10 Horizontal direction size 0 1T/dot	Character size setting in the horizont direction for the first line.
	113210	1	1 2T/dot	T : Display frequency cycle
в	TEOTAA	0	It should be fixed to "0".	
_	TEST11	1	Can not be used.	
С		0	HSZ20 Horizontal direction size 0 1T/dot	
C	HSZ20	1	1 2T/dot	
D	TEST12	0	It should be fixed to "0".	Character size setting in the horizon direction for the 2nd line to 12th line.
		1	Can not be used.	T : Display frequency cycle
		0	MODE1 MODE0 Output system Display mode 0 0 1 system Standard.(Note4)	Sets the RGB signal output system and the display mode for when 2
Е	MODE0 (Note 3)	1	0 1 1 system AND	pages are displayed at the same time
	(1 0 2 system — 1 1 1 system OR	See "DISPLAY FORM 2". MODE1(address12816) .

Notes 1. The mark () around the status value means the reset status by the "L" level is input to AC pin. 2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.

Registers marked with (Note 3) are found only in page 0, therefore the register value does not change when the DAF bit is set to "1".
 2 way settings are available by POPUP (address 12616).





DA	Decister		Contents	Demoite
DA	Register	Status	Function	Remarks
0	BCOL	0	Blanking of BLK0, BLK1	Sets all raster blanking
		1	All raster blanking	
1	B/F	0	Synchronize with the leading edge of horizontal synchronization.	Synchronize with the front porch or back porch of the horizontal
	(Note 3)	1	Synchronize with the trailing edge of horizontal synchronization.	synchronazation signal.
2	VMASK	0	Do not mask by VERT input signal	Set mask at phase comparison
	(Note 3)	1	Mask by VERT input signal	operating.
3	POLV	0	VERT pin is negative polarity	Set VERT pin polarity.
	(Note 3)	1	VERT pin is positive polarity	
4	POLH	0	HOR pin is negative polarity	Set HOR pin polarity.
•	(Note 3)	1	HOR pin is positive polarity	
5	BLK0	0	BLK1 BLK0 Blanking mode	Set blanking mode.
-	DERO	1	0 0 Matrix-outline size	See "DISPLAY SHAPE 2".
6	BLK1	0	0 1 Character size 1 0 Border size	
0	DLNI	1	1 1 Matrix-outline size (When DSPn (address 12416) = "0")	
		0	Border display of character	See "DISPLAY FORM1 (2)".
7	SYAD	1	Shadow display of character	_
8	DAMEDO	0	RAM not erased	When register RAMERS is set to "1",do not stop the display clock.
0	RAMERS	1	RAM erased	There is no need to reset because there is no register for this bit.
9	STOP	0	Oscillation of clock for display	It is a test bit (TEST13) in the page
0	3101	1	Stop the oscillation of clock for display	register, therefore fix it to "0".
A	DSPON	0	Display OFF	
		1	Display ON	
в	BLINK0	0	BLINK	Set blinking duty ratio.
		1	1 0 0 0 Blinking OFF	
С	BLINK1	0	0 1 25% 1 0 50%	
		1	1 1 75%	
D	BLINK2	0	Divided into 64 of vertical synchronous signal	Set blinking frequency.
		1	Divided into 32 of vertical synchronous signal	
E	MODE1	0	For setting, see MODE0 (address 12716).	Sets the RGB signal output system and the display mode for when 2

Notes 1. The mark () around the status value means the reset status by the "L" level is input to AC pin.

2. The page in which data is written is controlled by the DAF bit. When set to "0", data is written into page 0, whereas when set to "1", data is written into page 1.



SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

REGISTER SUPPLEMENTARY DESCRIPTION

- Setting external clock input and display frequency mode Setting external clock input and display frequency mode (by use of EXCK0 (12016), EXCK1 (12316) and DIV10 to DIV0 (12016), as explained here following.
 - (a) When (EXCK1, EXCK0) = (0, 0)External clock mode 1 Fosc = 6.3 to 80 MHz (VDD = 4.75 to 5.25 V) Fosc = 6.3 to 40 MHz (VDD = 2.50 to 3.50 V) Input from the TCK pin a constant-period continuous external clock that synchronizes with the horizontal synchronous signal. And input from HOR pin a constant period continuous horizontal synchronous signal. Never stop inputting the clock while displaying. Do not have to set a display frequency because the clock just as it is entered from outside is used as the display clock.
 - (b) When (EXCK1, EXCK0) = (0, 1)Internal clock mode Fosc = 20 to 110 MHz (VDD = 4.75 to 5.25 V) Clock input from the TCK pin is unnecessary. The multiply clock of the internally generated horizontal synchronous signal is used as the display clock. The display frequency is set by setting the multiply value of the horizontal synchronous frequency (of the display frequency) in DIV10 to DIV0 (address 12016). Also, set the

display frequency range. (See the next page.) Display frequency is calculated using the below expression.

Display frequency = Horizontal synchronous frequency x Multiply value

(c) When (EXCK1, EXCK0) = (1, 0) Setting disabled

(d) When (EXCK1, EXCK0) = (1, 1)External clock mode 2 Fosc = 20 to 110 MHz (VDD = 4.75 to 5.25 V)

Input from the TCK pin a constant-period continuous external clock that synchronizes with the horizontal synchronous signal. And input from HOR pin a constant-period continuous horizontal synchronous signal.

Never stop inputting the clock while displaying.

An internal clock which is in sync with the external input clock is used as the display clock.

Because the display frequency equals the external clock frequency, set N1 (division value) that satisfies the below expressions to DIV10 to DIV0 (address 12016) for make the display frequency is equal to the external clock frequency.

N1 = external clock frequency / horizontal synchronous frequency

$$N1 = \sum_{n=0}^{10} 2^n DIV_n$$

Also, set the display frequency range. (See the next page.)

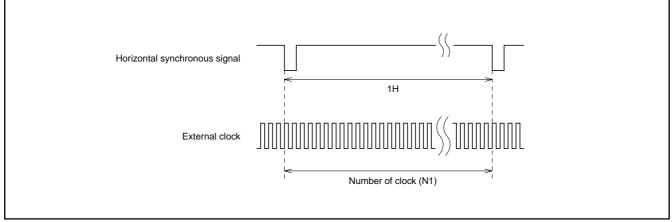


Fig. 4 Example of external clock input



SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

(2) To set display frequency range

Whenever setting display frequency (when EXCK1 = "0", EXCK0 = "1", or EXCK1 = "1", EXCK0 = "1"), always set the display frequency range in accordance with the display frequency. This range is set from DIVS0, DIVS1, DIVS2 (address 12016), RSEL0 address 12116) and RSEL1 (address 12216). Frequency ranges are given here below.

RSEL1	RSEL0	DIVS2	DIVS1	DIVS0	Display frequency range(MHz)
1	1	0	0	0	100.0 to 110.0
1	0	0	0	0	—
0	1	0	0	0	92.0 to 100.0
0	0	0	0	0	73.0 to 92.0
1	1	0	0	1	66.5 to 73.0
1	0	0	0	1	_
0	1	0	0	1	61.0 to 66.5
0	0	0	0	1	49.0 to 61.0
1	1	0	1	0	_
1	0	0	1	0	—
0	1	0	1	0	45.5 to 49.0
0	0	0	1	0	36.5 to 45.5
1	1	0	1	1	33.5 to 36.5
1	0	0	1	1	—
0	1	0	1	1	30.5 to 33.5
0	0	0	1	1	24.5 to 30.5
1	1	1	0	0	—
1	0	1	0	0	_
0	1	1	0	0	23.0 to 24.5
0	0	1	0	0	20.0 to 23.0

(3) Notes on setting display frequency

To change external clock (display) frequency or horizontal synchronization frequency, always use the following procedures.

To set EXCK1 = "0", EXCK0 = "1"

- (a) Turn the display OFF. ... DSPON (address 12816) = "0"
- (b) Set the display frequency. ... Set from DIV10 to DIV0, DIVS0, DIVS1, DIVS2 (address 12016), RSEL0 (address 12116) and RSEL1 (address 12216).
- (c) Wait 20 ms while the horizontal synchronization signal is being input.
- (d) Turn the display ON. ... DSPON (address 12816) = "1"

To set EXCK1 = "1", EXCK0 = "1"

- (a) Turn the display OFF. ... DSPON (address 12816) = "0"
- (b) Set the display frequency. ... Set from DIV10 to DIV0, DIVS0, DIVS1, DIVS2 (address 12016), RSEL0 (address 12116) and RSEL1 (address 12216).
- (c) Wait 20 ms while the horizontal synchronization signal and external clock are being input.

(d) Turn the display ON. ... DSPON (address 12816) = "1"





DISPLAY FORM 1

M35076-XXXSP has the following four display forms.

- (1) Blanking mode
 - Character size
 - : Blanking same as the character size.
 - Border size
 - : Blanking the background as a size from character.

Matrix-outline size

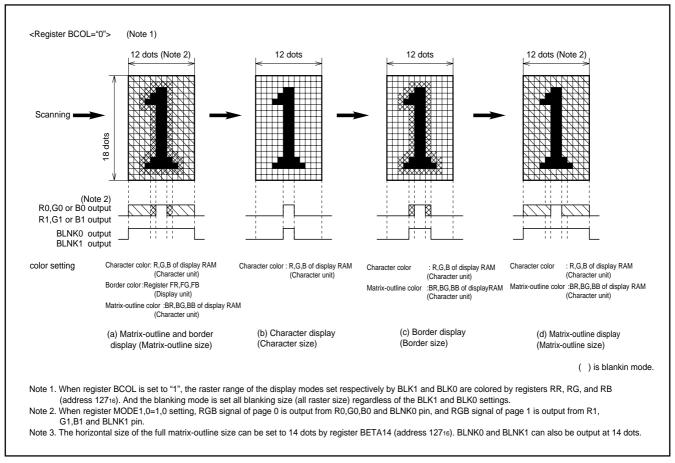
: Blanking the background 12×18 dot.

All blanking size

: When set register BCOL to "1", all raster area is blanking.

The display mode and blanking mode can be set line-by-line, as follows, from registers BCOL, BLK1, BLK0 (address 12816), DSP0 to DSP11 (address 12416).

DOOL	DI KA	DLKO	Line of D	SPn = "0"	Line of D	SPn = "1"	
BCOL	BLK1	BLK0	Display mode	Blanking mode	Display mode	Blanking mode	
	0	0	All matrix-outline border display	All matrix-outline size	All matrix-outline display	All matrix-outline size	
	0	1	Character display	Character size	Border display	Border size	
0	0 1 0	Border display	Border size	All matrix-outline display	All matrix-outlinesize		
	1	1 1 All matrix-ou		All matrix-outline size	Character display	Character size	
	0	0	All matrix-outline border display		All matrix-outline display		
1	0	1	Character display		Border display	1	
	1 0		Border display	All blanking size	All matrix-outline display	All blanking size	
	1	1	All matrix-outline display		Character display		





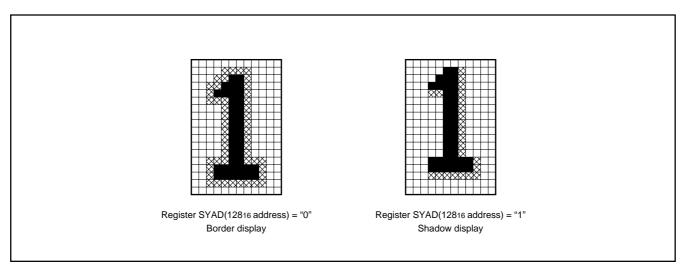


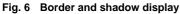


(2) Shadow display

When border display mode, if set SYAD (address 128₁₆) = "0" to "1", it change to shadow display mode. Border and shadow display are shown below.

Set shadow display color by BR, BG or BB of display RAM or by register FR, FG and FB (address 12716).







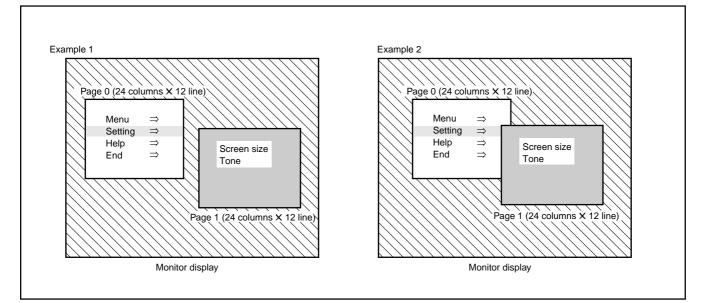
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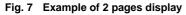
DISPLAY FORM 2

This IC can display both page 0 and page 1 at the same time.

Page 0: Set the DAF bit in each addresses to "0".

Page 1: Set the DAF bit in each addresses to "1".





- Example 1: Display position, display size, color, etc., can be freely set for each page, and the 2 pages can be displayed on top of each other or side-by-side.
- Example 2: RGB output of two pages can be outputted by one line or two lines by registers MODE0 (address 12716) and MODE1 (address 12816) and POPUP (address 12616). And, when the display range of the 2 pages overlap on the monitor screen at the time of an
 - one-line output, they can perform the following displays. (The POPUP register is effective only when MODE0 = "0" and MODE1 = "0".)

MODE1	MODE0	POPUP	Output system	Display mode
0	0	0	1 system	Standard (Page 1 priority)
0	0	1	1 system	Standard (Page 0 priority)
0	1		1 system	AND
1	0	—	2 systems	_
1	1		1 system	OR

(1) Output system

- (a) 1 system : Output RBG signal of both of page 0 and 1 from R0,G0,B0 and BLNK0 pin (For overlapping areas, refer to below.) (b) 2 systems : RBG signal of page 0 is output from R0,G0,B0 and BLNK0 pin, RBG signal of page 1 is output from R1,G1,B1 and
- (b) 2 systems : RBG signal of page 0 is output from R0,G0,B0 and BLNK0 pin, RBG signal of page 1 is output from R1,G1,B1 and BLNK1 pin.
- (2) Display mode (Overlapping areas of Page 0 and 1)
 - (a) Standard (page 1 priority).. Page 1 has priority in overlapping areas. Page 0 is not displayed in those areas.
 - (b) Standard (page 0 priority).. Page 0 has priority in overlapping areas. Page 1 is not displayed in those areas.
 - (c) AND In overlapping areas, the RGB output of the 2 pages is AND processed and output.
 - (d) OR In overlapping areas, the RGB output of the 2 pages is OR processed and output.

Note : Set 0 (port output) to control register PTC2, PTC4 and PT67 except at 2 systems output setting (MODE1=1,MODE0=0.)





CHARACTER FONT

Images are composed on a 12 \times 18 dot matrix, and characters can be linked vertically and horizontally with other characters to allow the display the continuous symbols.

Character code FF₁₆ is fixed as a blank without background. Therefore, cannot register a character font in this code.

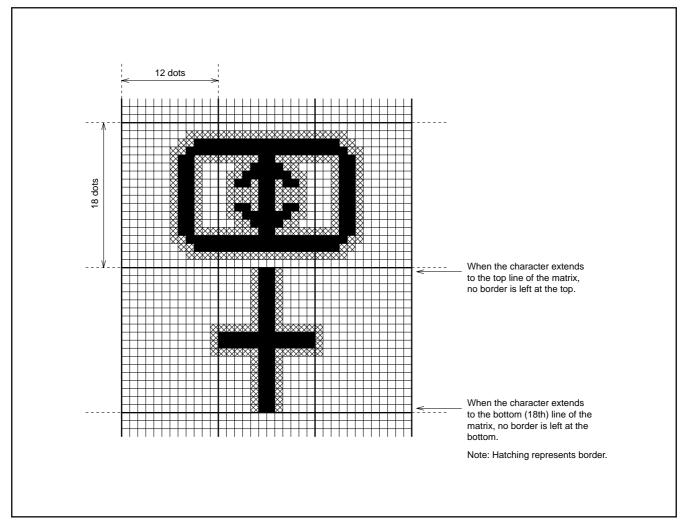


Fig. 8 Example of border display



SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

DATA INPUT EXAMPLE

Data of display RAM and display control registers can be set by the 16-bit serial input function or the l^2 C-BUS serial input function. Example of data setting is shown in Figure 9 (at EXCK0 = "1", EXCK1 = "0" setting).

Data input example (M35076-XXXSP)

Address	s/data	DAF (Note1)	DAE	DAD	DAC	DAB	DAA	DA9	DA8	DA7	DA6	DA5	DA4	DA3	DA2	DA1	DA0		Remarks	
								20	00m s	ec ho	ld							5	System set up (Note 4)	
Address	12016	0	0	0	0	0	0	0	1	0	0	1	0	0	0	0	0	A	Address setting	
Data	12016	0	1	DIVS2	DIVS1	DIVSO	DIV10	DIV9	DIV8	DIV7	DIV6	DIV5	DIV4	DIV3	DIV2	DIV1	DIV0		Frequency value setting (Note2)	
Data	12116	0	RSELO	PTD7	PTD6	1	PTD4	1	PTD2	1	1	1	0	1	0	1	1		Output setting	
Data	12216	0	RSEL1	0	0	0	HP10	HP9	HP8	HP7	HP6	HP5	HP4	HP3	HP2	HP1	HP0		Horizontal display location settin	
Data	12316	0	0	0	0	0	0	VP9	VP8	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0	0 p	Vertical display location setting	
Data	12416	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	page	Display form setting	
Data	12516	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		Character size setting	
Data	12616	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		Character size setting	
Data	12716	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		Color, character size setting	
Data	12816	0	0	0	0	0	0	0	0	0	0	0	POLH	POLV	0	0	0	F	Page 0 display OFF	
Address	12216	0	0	0	0	0	0	0	1	0	0	1	0	0	0	1	0	A	Address setting	
Data	12216	1	0	0	0	0	HP10	HP9	HP8	HP7	HP6	HP5	HP4	HP3	HP2	HP1	HP0		Horizontal display location settin	
Data	12316	1	0	0	0	0	0	VP9	VP8	VP7	VP6	VP5	VP4	VP3	VP2	VP1	VP0		Vertical display location setting	
Data	12416	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1 p	Display form setting	
Data	12516	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	page	Character size setting	
Data	126 16	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		Character size setting	
Data	12716	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0		Color, character size setting	
Data	12816	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	F	Page 1 display OFF	
								20	00m s	ec ho	ld							E	Be stable / Waiting time	
Data	00016	0	BB	BG	BR	BLINK	В	G	R	C7	C6	C5	C4	C3	C2	C1	C0			
				ickgrou coloring		Blink -ing	Char	racter	color			(Charac	ter cod	le			0 page	Character setting	
Data	11F16	0	BB	BG	BR	BLINK	в	G	R	C7	C6	C5	C4	C3	C2	C1	CO			
Address	00016	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	_		
Data	00016	1	BB	BG	BR	BLINK	В	G	R	0	C6	C5	C4	C3	C2	C1	CO			
				ickgrou coloring		Blink -ing	Char	acter o	color				Cha	racter of	code			1 page	Character setting	
Data	11F16	1	BB	BG	BR		В	0	R	0	C6	C5	C4	C3	C2	C1	C0	Ű		
Address		0	0	0	0	0	0	0	1	0	0	1	0	1	0	0	0		Address setting	
Data	12816	1	0	0	0	0	1	0	0	0	1	1	0	0	0	0	0	F	Page 1 display ON Display form setting (Note 3)	
Address	12816	0	0	0	0	0	0	0	1	0	0	1	0	1	0	0	0	A	Address setting	
Data	12816	0	0	0	0	0	1	0	0	0	1	1	POLH	POLV	0	0	0		Page 0 display ON Display form setting (Note 3)	

Notes 1 : The page in which data is written is controlled by the address. To write data into page 0, set "0". To write data into page 1, set "1". 2 : Input a continuous clock of constant period from the TCK pin. Also, input a horizontal synchronous signal into the HOR pin and a vertical synchronous signal into the VERT pin.

3 : Matrix-outline display in this data.

4 : Secure the waiting time of 200ms after releasing AC, and set data from setting the display frequency (setting of the register).

5 : Set data to display RAM at internal clock (display clock) is stabilized.

Fig 9. Example of data setting





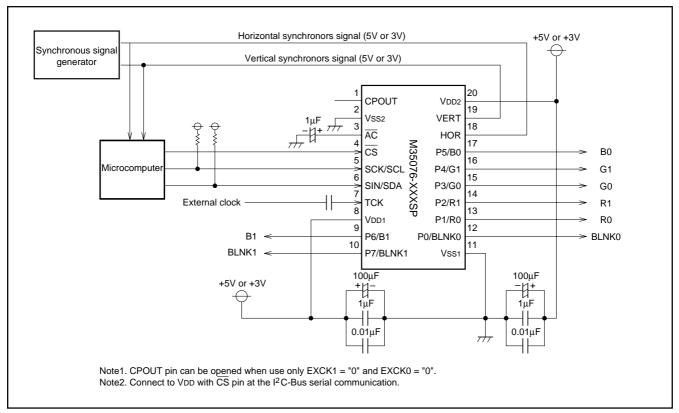
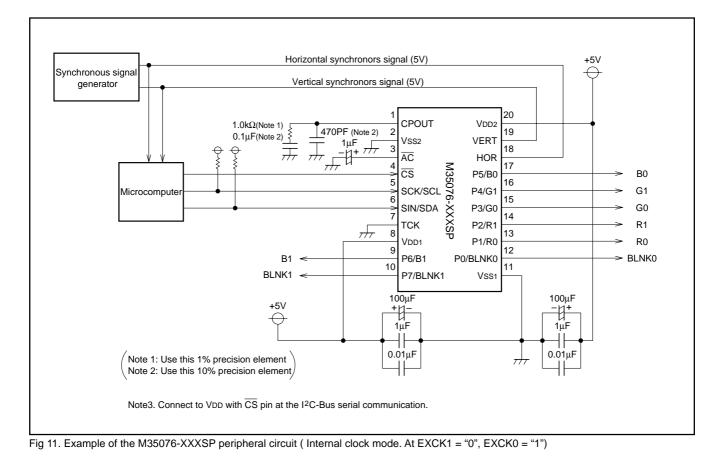


Fig 10. Example of the M35076-XXXSP peripheral circuit (External clock mode 1. At EXCK1 = "0", EXCK0 = "0")







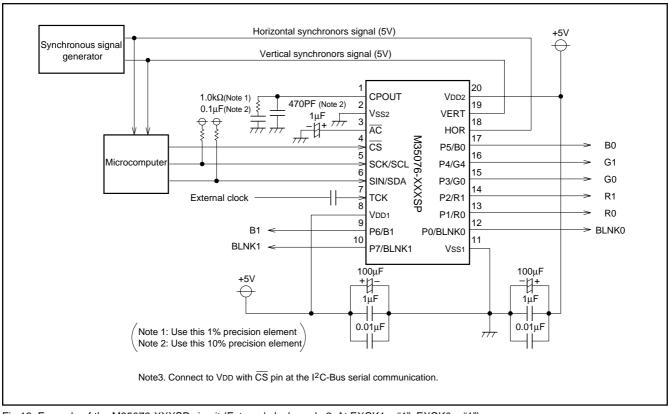


Fig 12. Example of the M35076-XXXSP circuit (External clock mode 2. At EXCK1 = "1", EXCK0 = "1")





DATA INPUT 1

(1) The16-bit communication function
(a)Serial data should be input with the LSB first.
(b)The address consists of 16 bits.
(c)The data consists of 16 bits.

(d)The 16 bits in the SCK after the \overline{CS} signal has fallen are the address, and for succeeding input data, the address is incremented every 16 bits. Therefore, it is not necessary to in put the address from the second data.

Note. Stop the input to $\overline{\text{SCK}}$ pin and fix it to "H" at $\overline{\text{CS}}$ pin "H" level.

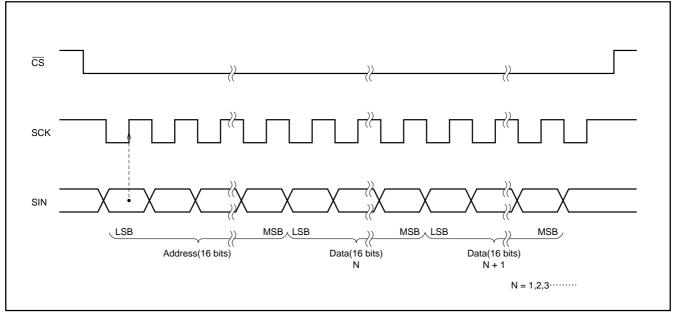


Fig.13 Serial input timing





(2)Timing requirements

Data	input

Symbol	Parameter		Limits		Unit	Remarks	
Cyrribol	i alancici	Min.	Тур.	Max.	Onit	Remarks	
tw(SCK)	SCK width	200	—	—	ns		
tsu(CS)	CS setup time	200	—	—	ns		
th(CS)	CS hold time	2	—	—	μs	Soo Figuro 14	
tsu(SIN)	SIN setup time	200	—	—	ns	See Figure 14	
th(SIN)	SIN hold time	200		—	ns		
tword	1 word writing time	10	—	—	μs		

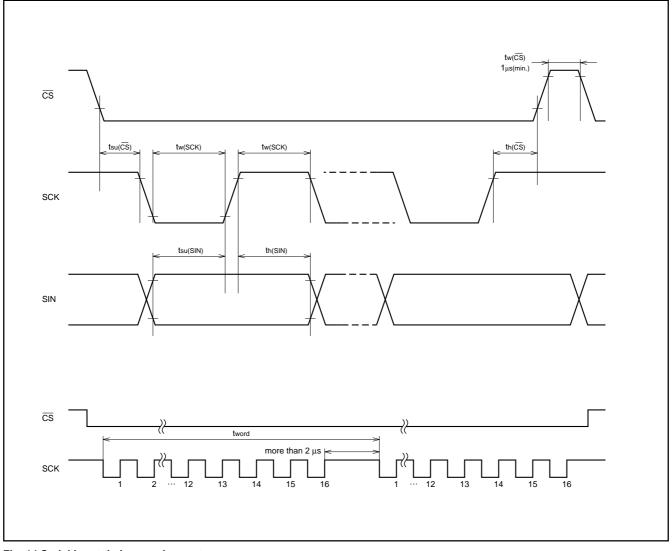


Fig. 14 Serial input timing requirements



SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

DATA INPUT 2

(1) The I^2C -Bus communication function (at VDD=5V only)

This IC has a built-in data transmission interface which utilizes 2 unidirectional buses. In communications, this IC functions as a slave reception device. Set \overline{CS} pin to "H" level at the I²C-Bus serial input communication.

The IC is synchronized with the serial clock (SCL) sent from the master device and receives the data (SDA). Communications are controlled from the start/stop states. Also, always input the control byte after attaining the start state.

The below chart shows the start/stop state and control byte configuration.

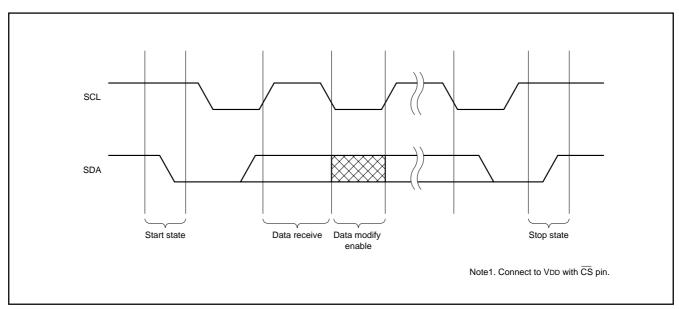


Fig. 15 Start state / Stop state

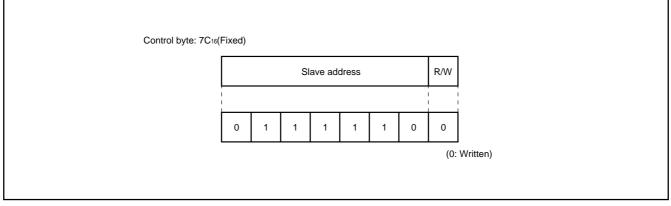
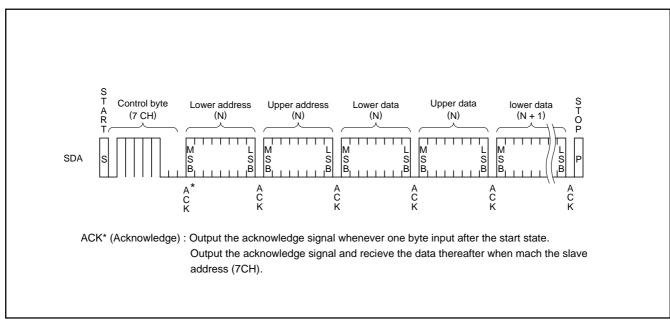


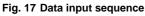
Fig. 16 Control byte configuration



SCREEN CHARACTER and PATTERN DISPLAY CONTROLLERS

- (2) Data input (Sequence)
 - (a) Addresses are consists of 16 bits.
 - (b) Data is consists of 16 bits.
 - (c) Addresses and data are communicated in 8-bit units. Input the lower 8 bits before the upper 8 bits. Make input from the MSB side.
 - (d) After the start state has been attained and the control byte (7CH) received, the next 16 bits (2 bytes) are for inputting the address. Addresses are increased in increments for every 16 bits (2 bytes) of data input thereafter. As a result, it is not necessary to input the address from the second data.
- Note: During external synchronous, stop the external clock input from the TCK pin while inputting data.









(3) Timing requirement Data input

			Lir	nits			
Symbol	Parameter	Тур.	mode	High-spe	ed mode	Unit	Remarks
		Min.	Max.	Min.	Max.		
fCLK	Clock frequency	0	100	0	400	KHz	
thigh	HIGH period of Clock	4000	-	600	-	ns	
tLOW	LOW period of Clock	4700	-	1300	-	ns	
tR			1000	20+(Note)	300		
IR	SDA & SCL rise time	-	1000	0.1Св	000	ns	
tF			300	20+(Note)	300		
ι -	SDA & SCL fall time	-	500	0.1Св	500	ns	
tHD : STA	Hold time at START status	4000	-	600	-	ns	
ts∪ : STA	Set up time at START status	4700	-	600	_	ns	Only at START state repeating generation
thd : DAT	Data input hold time	0	-	0	-	ns	
ts∪ : DAT	Data input setup time	250	_	100	_	ns	
ts∪ : STO	Set up time at STOP state	4000	-	600	-	ns	
tBUF	Bus release time	4700	_	1300	_	ns	Time must be re- leased bus before next transmission
tSP	Input filter / spike suppress (SDA & SCL pin)	N/A	N/A	0	50	ns	

Note. C_B = total capacitance of 1 bus line.

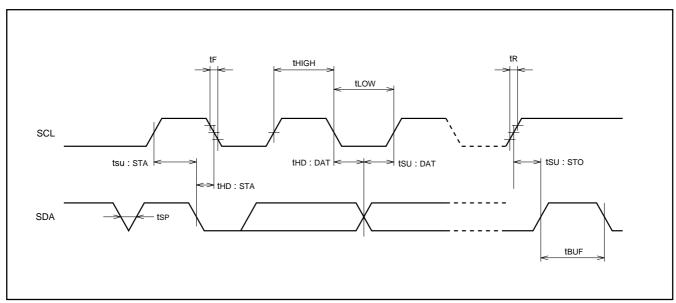


Fig. 18 Data input timing





ABSOLUTE MAXIMUM RATINGS (VDD = 5.00V, Ta = -20 to +85°C, unless otherwise noted)

Symbol	Parameter	Conditions	Ratings	Unit
Vdd	Supply voltage	With respect to Vss.	-0.3 to +6.0	V
Vi	Input voltage		$V\text{SS}-0.3 \leq \text{VI} \leq \text{VDD} + 0.3$	V
Vo	Output voltage		$Vss \leq Vo \leq Vdd$	V
Pd	Power dissipation	Ta = +25°C	+300	mW
Topr	Operating temperature		-20 to +85	°C
Tstg	Storage temperature		-40 to +125	°C

RECOMMENDED OPERATING CONDITIONS (VDD = 5.00V, Ta = -20 to +85°C, unless otherwise noted)

Symbol	Parameter		Limits			Unit	
Cymbol	i alametei			Min.	Тур.	Max.	Offic
Vdd		5V		4.75	5.0	5.25	V
	Supply voltage	3V		2.50	3.0	3.50	V
Vін	"H" level input voltage	AC, CS, HOR, VERT		0.8Vdd	Vdd	Vdd	V
		SCK/SCL, SIN/SDA		0.7Vdd	Vdd	Vdd	V
VIL	"L" level input voltage	AC, CS, HOR, VERT		0	0	0.2Vdd	V
		SCK/SCL, SIN/SDA		0	0	0.3Vdd	V
	Oscillating frequency for display	External clock mode 1	VDD = 4.75 to 5.25 V	6.3	_	80.0	MHz
_			VDD = 2.50 to 3.50 V	6.3	—	40.0	MHz
Fosc		External clock mode 2	VDD = 4.75 to 5.25 V	20.0	_	110.0	MHz
		Internal clock mode	VDD = 4.75 to 5.25 V	20.0	_	110.0	MHz
H.sync	hc Horizontal synchronous signal input frequency		VDD = 4.75 to 5.25 V	15.0	_	130.0	kHz
			VDD = 2.50 to 3.50 V	15.0	_	60.0	kHz

ELECTRICAL CHARACTERISTICS 1 VDD=5V (VDD = 5.00V, Ta = 25°C, unless otherwise noted)

Symbol	Parameter		Test conditions	Limits			Unit
Cymbol				Min.	Тур.	Max.	Onit
Vdd	Supply voltage		Ta = -20 to +85°C	4.75	5.0	5.25	V
IDD	Supply current		VDD = 5.00V	_	40	60	mA
Vон	"H" level output voltage	P0 to P7 (Note1)	Vdd = 4.75V, Iон = -0.4mA	3.5	_	_	V
VOH		CPOUT	Vdd = 4.75V, IOн = -0.05mA				
Vol	"L" level output voltage	P0 to P7 (Note2)	VDD = 4.75V, IOL = 0.4mA		_	0.4	V
		CPOUT	VDD = 4.75V, IOL = 0.05mA				
		SIN/SDA	VDD = 4.75V, IOL = 3.0mA				
Ri	Pull-up resistance AC, CS		VDD = 5.00V	10	30	100	kΩ
Vтск	External clock input width		$4.75V \le VDD \le 5.25V$	0.6Vdd	—	0.9Vdd	V

Notes 1. The current from the IC must not exceed – 0.4 mA/port at any of the port pins (P0 to P7).

2. The current flowing into the IC must not exceed 0.4 mA/port at any of port pins (P0 to P7).





ELECTRICAL CHARACTERISTICS 2 VDD=3V (VDD = 3.00V, Ta = 25°C, unless otherwise noted)

Symbol	Parameter	Test conditions	Limits			Unit
	i alametei		Min.	Тур.	Max.	Onic
Vdd	Supply voltage	Ta = -20 to +85°C	2.50	3.00	3.50	V
IDD	Supply current	VDD = 3.00V	_	20	30	mA
Vон	"H" level output voltage P0 to P7 (Note1)	VDD = 2.70V, IOH = -0.1mA	2.30			V
Vol	"L" level output voltage P0 to P7 (Note2)	Vdd = 2.70V, IOH = 0.1mA	-	_	0.4	V
Ri	Pull-up resistance \overline{AC} , \overline{CS}	VDD = 3.00V	30		150	kΩ
Vтск	External clock input width	$2.20V \leq V\text{DD} \leq 3.50V$	0.7Vdd	_	Vdd	V

Notes 1. The current from the IC must not exceed -0.1 mA/port at any of the port pins (P0 to P7).

2. The current flowing into the IC must not exceed 0.1 mA/port at any of port pins (P0 to P7).





NOTE FOR SUPPLYING POWER

(1)Timing of power supplying to \overline{AC} pin

The internal circuit of M35076-XXXSP is reset when the level of the auto clear input pin \overline{AC} is "L". This pin in hysteresis input with the pull-up resistor.

The timing about power supplying of \overline{AC} pin is shown in Figure 19.

After supplying the power (VDD and Vss) to M35076-XXXSP and the supply voltage becomes more than $0.8 \times VDD$, it needs to keep VIL time; tw of the \overline{AC} pin for more than 1ms.

Start inputting from microcomputer after \overline{AC} pin supply voltage becomes more than $0.8 \times VDD$ and keeping 200ms wait time.

(2)Timing of power supplying to VDD1 and VDD2. Supply power to VDD1 and VDD2 at the same time.

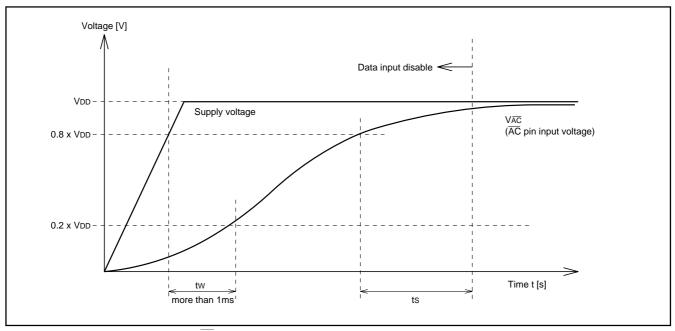


Fig. 19 Timing of power supplying to AC pin

PRECAUTION FOR USE

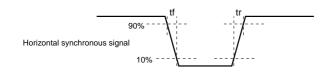
Notes on noise and latch-up

In order to avoid noise and latch-up, connect a bypass capacitor (≈0.1µF) directly between the VDD1 pin and Vss1 pin, and the VDD2 pin and Vss2 pin using a heavy wire.

Note for waveform timing of the horizontal signals to the HOR pin Set horizontal synchronous signal edge* waveform timing to under 5ns and input to HOR pin.

Set only the side which set by B/\overline{F} register waveform timing under 5ns and input to HOR pin.

*: Set front porch edge or back porch edge by B/F register.



DATA REQUIRED FOR MASK ROM ORDERING

Please send the following data for mask orders.

- (1) M35076-XXXSP mask ROM order confirmation form
- (2) 20P4B mark specification form
- (3) ROM data : EPROMs or floppy disks
 - *In the case of EPROMs, thres sets of EPROMs are required per pattern.
 - *In the case of floppy disks, 3.5-inch 2HD disk (1BM format) is required per pattern.



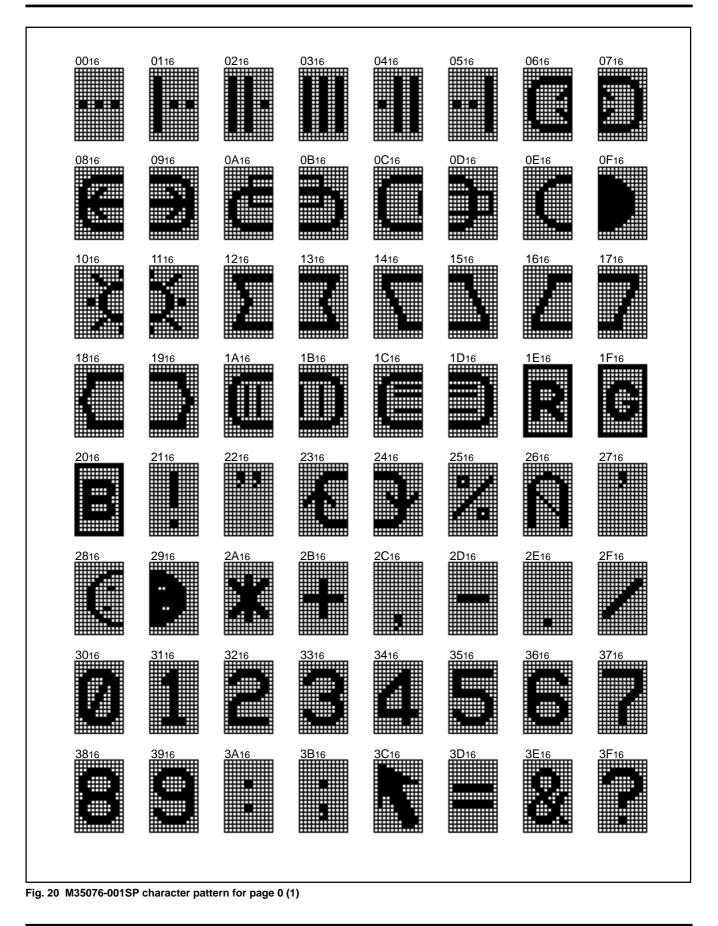


STANDARD ROM TYPE : M35076-001SP

M35076-001SP is a standard ROM type of M35076-XXXSP. The character patterns for 0 page are fixed to the contents of Figure 20 to 23, the character patterns for page 1 are fixed to the contents of Figure 24 to 27.











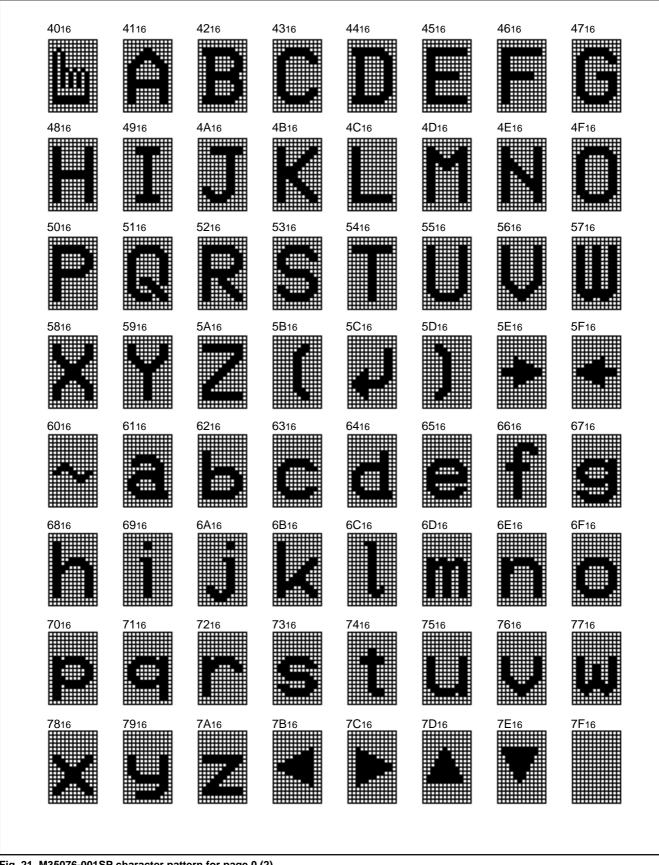


Fig. 21 M35076-001SP character pattern for page 0 (2)





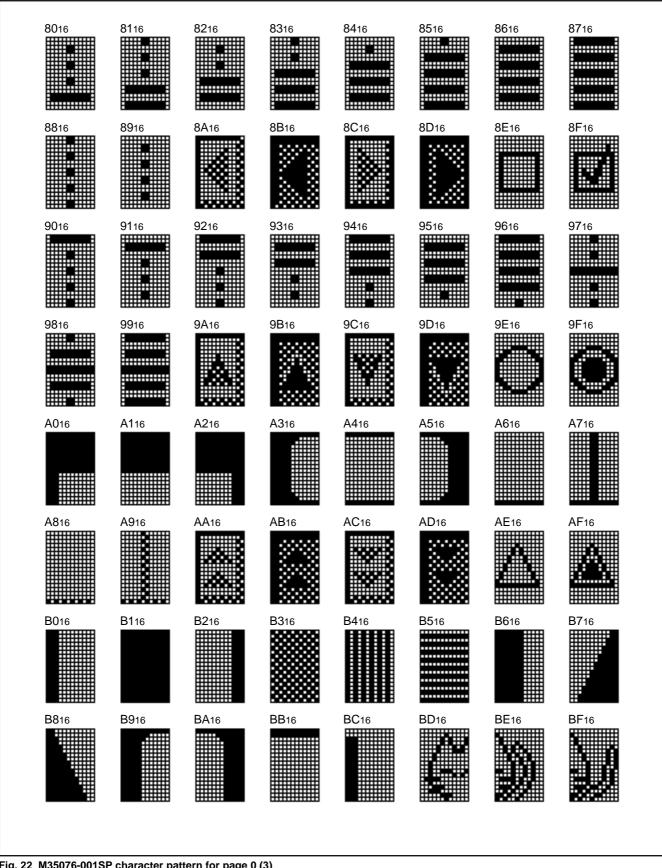
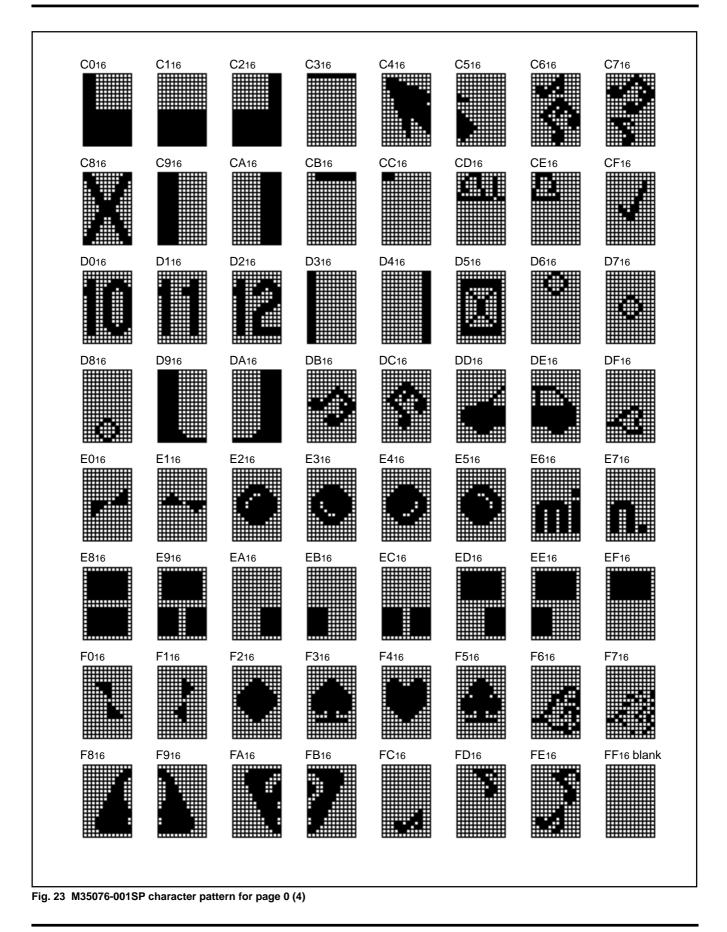


Fig. 22 M35076-001SP character pattern for page 0 (3)

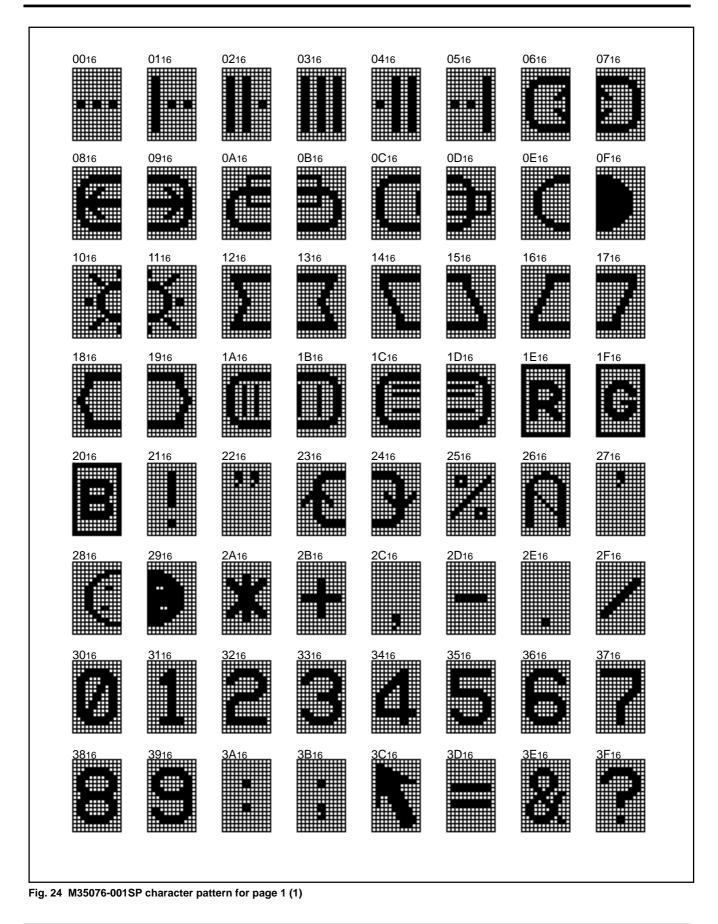






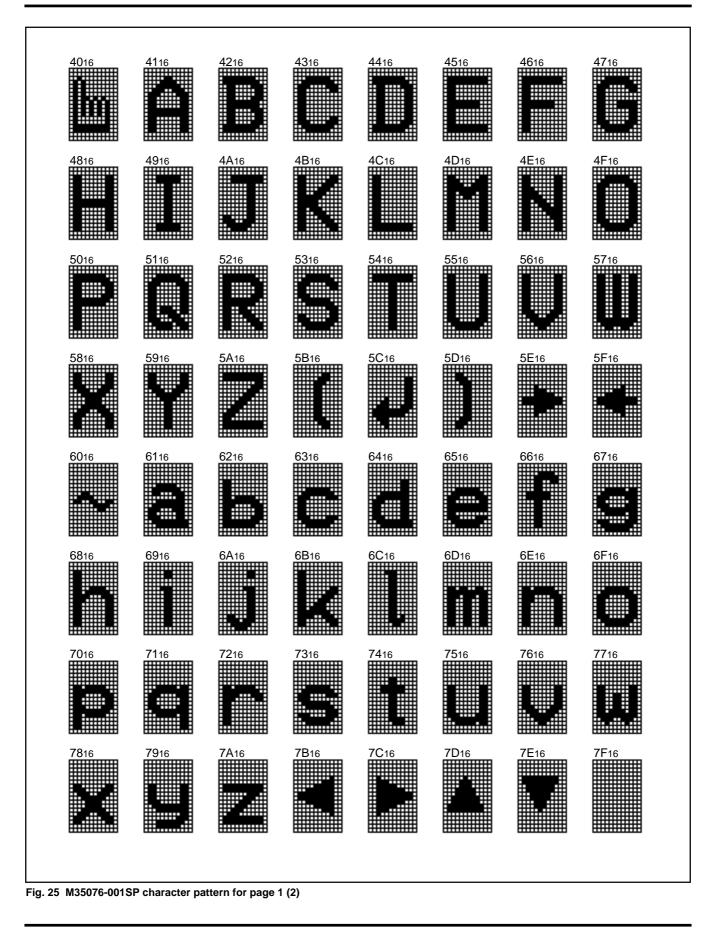






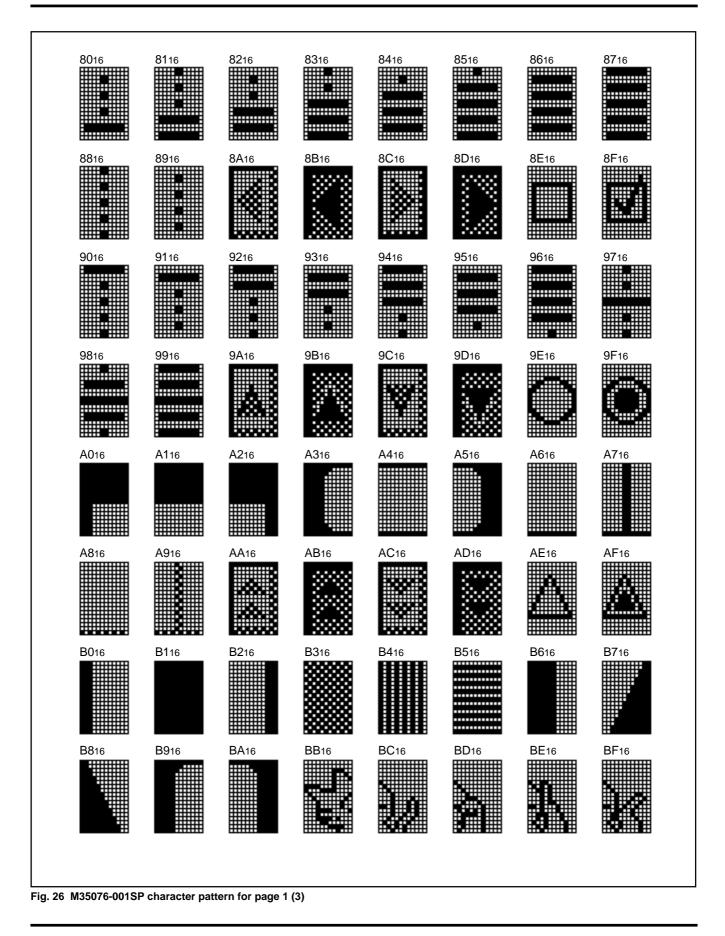
















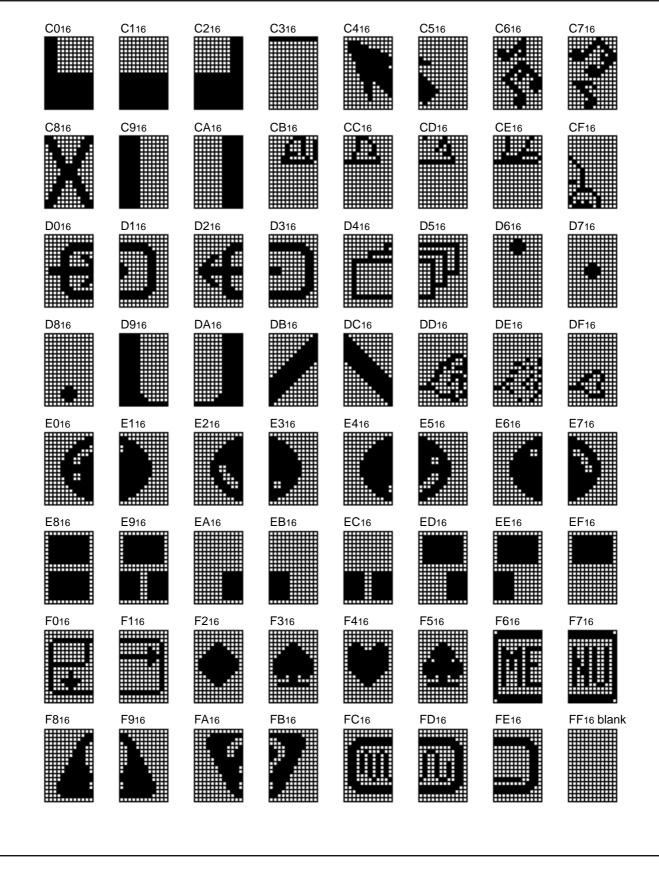
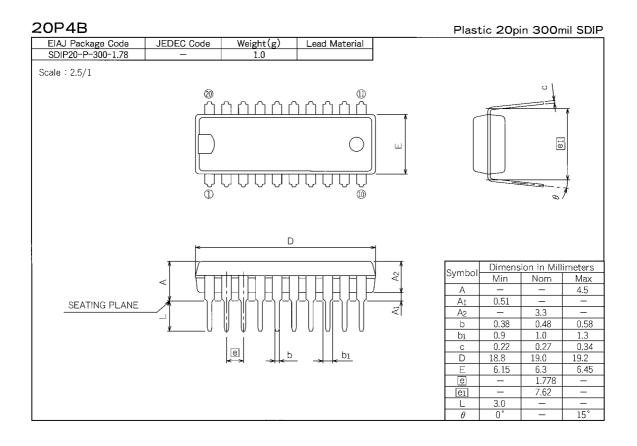


Fig. 27 M35076-001SP character pattern for page 1 (4)





PACKAGE OUTLINE







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REVISION DESCRIPTION LIST

M35076-XXXSP Data Sheet

Rev.	Revision Description	Rev.
No.		date
1.0	First Edition	0203
1		